SQP90142E

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Vishay Siliconix

Automotive N-Channel 200 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	200			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0153			
I _D (A)	78.5			
Configuration	Single			
Package	TO-220			

FEATURES

- TrenchFET® power MOSFET
- · Package with low thermal resistance

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N-Channel MOSFET

- AEC-Q101 qualified
- 100 % $\rm R_g$ and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

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AUTOMOTIVE

ABSOLUTE MAXIMUM RATIN	GS (T _C = 25 °C, unless	otherwise noted	ł)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	200	V	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current	T _C = 25 °C	1	78.5		
	T _C = 125 °C	I _D	45		
Continuous source current (diode conduction) a		I _S	120	А	
Pulsed drain current ^b		I _{DM}	170		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	64		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	205	mJ	
Maximum power dissipation ^b	T _C = 25 °C	- P _D	250	W	
	T _C = 125 °C		83	vv	
Operating junction and storage temperatur	e range	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^c	R _{thJA}	40	°C/W
Junction-to-case (drain)	ction-to-case (drain)		0.6	0/10

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR4 material).

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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT		
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μΑ	200	-	-		
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3.0	3.5	V	
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 200 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 200 V, T _J = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	V _{DS} = 200 V, T _J = 175 °C	-	-	600		
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	40	-	-	Α	
		$V_{GS} = 10 V$	I _D = 20 A	-	0.0127	0.0153		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	-	-	0.0310	Ω	
		$V_{GS} = 10 V$	I _D = 20 A, T _J = 175 °C	-	-	0.0404	1	
Forward transconductance ^b	9 _{fs}	V _{DS}	= 15 V, I _D = 20 A	-	54	-	S	
Dynamic ^b								
Input capacitance	C _{iss}			-	3200	4200		
Output capacitance	C _{oss}	V _{GS} = 0 V V _{DS} = 25 V, f = 1 MHz		-	1300	1750	pF	
Reverse transfer capacitance	C _{rss}			-	80	110	1	
Total gate charge ^c	Qg			-	55	85		
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{DS} = 100 \text{ V}, \text{ I}_{D} = 9 \text{ A}$	-	14	-	nC	
Gate-drain charge ^c	Q _{gd}]		-	16.5	-		
Gate Resistance	Rg	f = 1 MHz		1.40	2.92	4.40	Ω	
Turn-on delay time ^c	t _{d(on)}			-	17	30		
Rise time ^c	t _r	V _{DD} =	100 V, R _L = 11.1 Ω	-	8	15	ns	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 9 A,$	V_{GEN} = 10 V, R_{g} = 1 Ω	-	39	60		
Fall time ^c	t _f			-	16	30		
Source-Drain Diode Ratings and Charac	cteristics ^b							
Pulsed current ^a	I _{SM}			-	-	170	Α	
Forward voltage	V _{SD}	$I_F = 20 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.82	1.5	V	
Body diode reverse recovery time	t _{rr}			-	129	260	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs		-	685	1400	nC	
Reverse recovery fall time	ta			-	106	-	ns	
Reverse recovery rise time	t _b			-	26	-		
							1	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

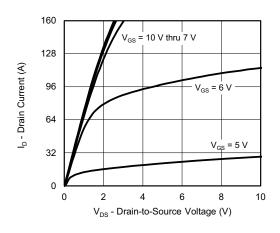
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

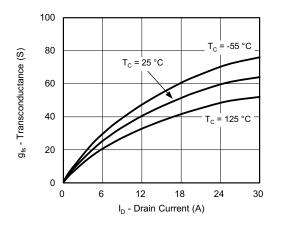
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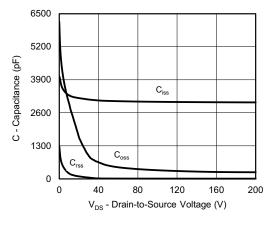
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



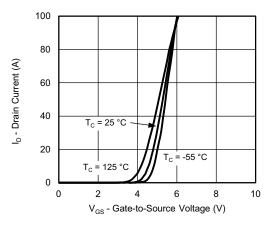
Output Characteristics



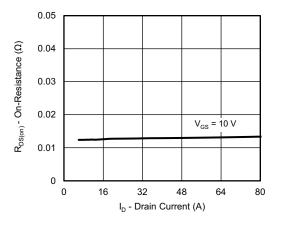
Transconductance



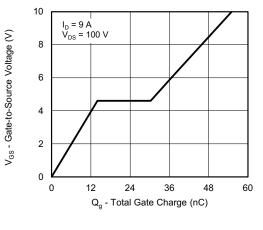
Capacitance



Transfer Characteristics



On-Resistance vs. Drain Current



Gate Charge

S16-2614-Rev. A, 26-Dec-16

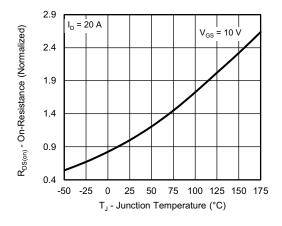
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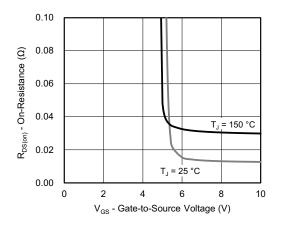
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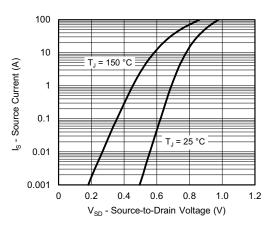
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



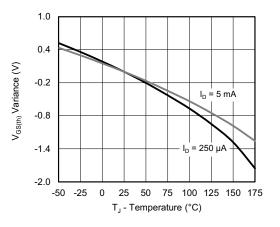
On-Resistance vs. Junction Temperature



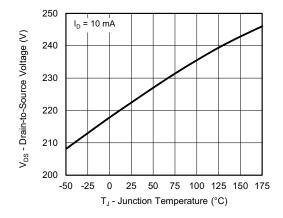
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



Threshold Voltage

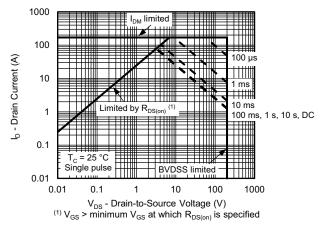


Drain Source Breakdown vs. Junction Temperature

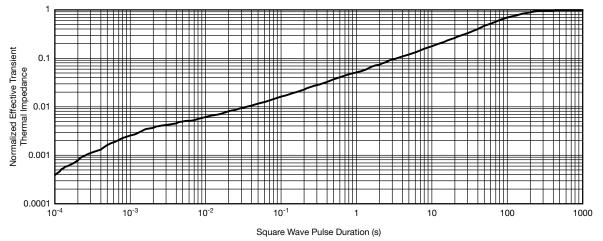
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)





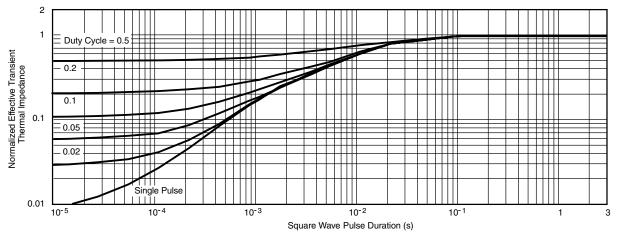


Normalized Thermal Transient Impedance, Junction-to-Ambient



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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

S16-2614-Rev. A, 26-Dec-16

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76843



TO-220AB



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
	0413-Rev. P,		0.102	0.118

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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Revision: 01-Jan-2025

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